

2021 3RD INTERNATIONAL CONFERENCE ON MECHANICAL AND AEROSPACE SYSTEMS (ICMAS 2021)

Cairo, Egypt|December 8-10, 2021

CALL FOR PAPERS

Topics of interest for submission include, but are not limited to:

Mechanical Engineering:

- Applied Mechanics
- Automation
- Fluid Dynamics
- Fuels and Combustion
- Materials Synthesis and Processing
- Mechanical Engineering
- Solid Mechanics and Materials

Aerospace Systems and Technology:

- Aerodynamics
- Airport Management and Operations
- Atmospheric Measurement
- Attitude maneuver control
- Communications techniques
- Managing Creativity and Innovation
- Turbomachinery

More information, please visit:

<http://www.icmas.org/cfp.html>

IMPORTANT DATES

Submission Due: **October 1st, 2021**

Notification Day: **October 25th, 2021**

Registration Due: **November 10th, 2021**

CONTACT US

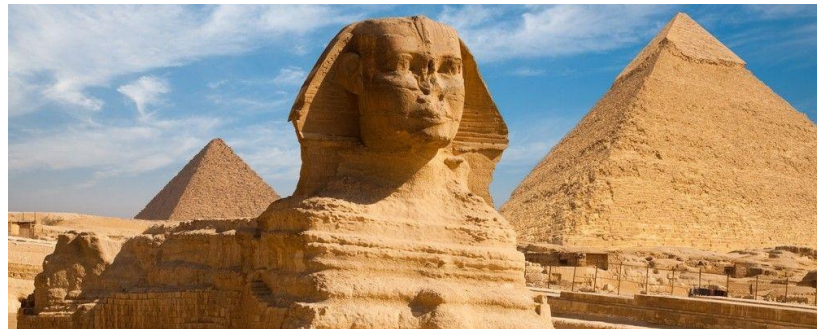
Conference Secretary: Ms. Sharon Liu

Email: icmas@outlook.com

Phone: 001(559)-8624927(English)/+86-28-6302-3585(Chinese)

(working day only/10:00-18:00)

Website: <http://www.icmas.org/>



ICMAS 2021

2021 3rd International Conference on Mechanical and Aerospace Systems (ICMAS 2021) will be held in the British University in Egypt, Cairo, Egypt during December 8-10, 2021. ICMAS 2021 is supported by the British University in Egypt, Cairo, Egypt.

ICMAS main objectives are to address, explore and exchange information on the state-of-the-art in all types of Mechanical and Aerospace Systems. As coronavirus spreads worldwide, we welcome authors to join in the conference by media method, like online presentation, video presentation, etc.



SUBMISSION

1. Full Paper (Presentation & Publication)

2. Abstract (Presentation only)

Online Submission System:

<http://www.zmeeting.org/register/icmas2021>

Email: icmas@outlook.com

More information, please visit:

<http://www.icmas.org/sub.html>

PUBLICATION

After a careful reviewing process, all accepted papers after proper registration and presentation, will be published in ICMAS 2021 Conference Proceedings, which will be indexed by **El Compindex**, **Scopus**, Thomson Reuters (WoS), Inspec, et al.